

Comparison of SOLR and TRL Calibrations

David K. Walker and Dylan F. Williams
National Institute of Standards and Technology
325 Broadway, Boulder, CO 80303

Ph: [+1] (303)497-3138 Fax: [+1] (303)497-3122 E-mail: dylan@boulder.nist.gov

***Abstract-* We examine a short-open-load-reciprocal scattering parameter calibration in both in-line and orthogonal probe configurations. We explore its standard definitions and verify its accuracy by comparing it to a multilayer thru-reflect-line calibration.**

INTRODUCTION

We study two-port short-open-load-reciprocal (SOLR) probe-tip calibrations [1] with both in-line and orthogonal probe-head placements. We verify the accuracy of the SOLR calibration by comparing it to a multilayer thru-reflect-line (TRL) calibration [2] and show that the differences are due, in large part, to the definitions of the SOLR standards.

The SOLR calibration [1], [3] makes no assumptions about the transmission standard used other than that it be reciprocal (i.e., $S_{12} = S_{21}$). A significant advantage of this permutation of the short-open-load-thru (SOLT) calibration is that it is applicable to orthogonal probing systems where the thru standard is difficult to implement: in an orthogonal probing environment, a transmission line with a 90° bend suffices for the reciprocal standard.

In this paper we compare in-line and orthogonal SOLR calibrations with accurate multilayer TRL calibrations. We study the in-line case to verify the method without the additional complications of the 90° bend in the reciprocal standard of the SOLR calibration and to examine how the standard

definitions effect the accuracy of the SOLR calibration. We study the orthogonal calibration separately to investigate the effects of the bend.

REFERENCE CALIBRATION

We assessed the accuracy of the SOLR calibrations by comparing them to a multilayer TRL reference calibration with the method of [4]. This method determines an upper bound for $|S'_{ij} - S_{ij}|$, where S'_{ij} are the S-parameters of any passive device measured by the thru-reflect-resistor calibration, S_{ij} are the S-parameters measured by the TRL calibration, $|S_{11}| \leq 1$, $|S_{22}| \leq 1$, and $|S_{12} S_{21}| \leq 1$.

The TRL artifacts used for the reference calibration consisted of a coplanar waveguide (CPW) thru line 0.550 mm long, five longer lines of length 2.685 mm, 3.750 mm, 7.115 mm, 20.245 mm, and 40.550 mm; and symmetric shorts offset 0.225 mm from the beginning of the line. The CPW lines were made by evaporating a 50 nm thick adhesion layer of titanium, and then a 500 nm thick gold film, onto the 500 μm thick gallium arsenide substrate. The lines had a center conductor width of 64 μm separated from two 261.5 μm wide ground planes by 42 μm gaps. We set the reference plane of the TRL calibration 25 μm in front of the physical beginning of the TRL lines, and set its reference impedance to 50 Ω with the method of [5].

We used a commercial software package and shorts, loads, thrus, and bends fabricated on a

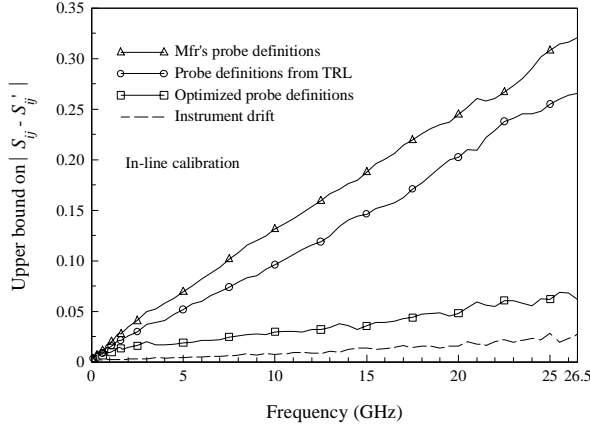


Fig. 1. Measurement error bounds for an in-line SOLR calibration. The various curves represent different SOLR standard definitions. The error bound due to test set drift and contact errors is shown as a dashed line for comparison.

commercial impedance standard substrate (ISS) to perform the SOLR calibrations. The short standard is realized on this ISS by placing the probes on a uniform sheet of conductive gold metal. The open standard is realized by raising the probes in the air, and the matched loads consisted of 50 μm square thin-film resistors laser-trimmed to 50 Ω connected to 50 μm wide vertical contact pads.

IN-LINE SOLR CALIBRATION

We first performed the SOLR calibration using the standard definitions supplied by the manufacturer. Table 1 lists the values of C_o , the shunt capacitance of the open standard, L_s , the series inductance of the short standard, and L_l , the series inductance of the matched load terminations they specified, as well as others used in these experiments. These definitions depended on the probe type and probe pitch, as explained in [6], [7], [8], and [9].

Figure 1 compares our in-line TRL calibration to this SOLR calibration with the curve marked with triangles; the dashed curve shows the instrument drift determined from TRL calibrations performed at the

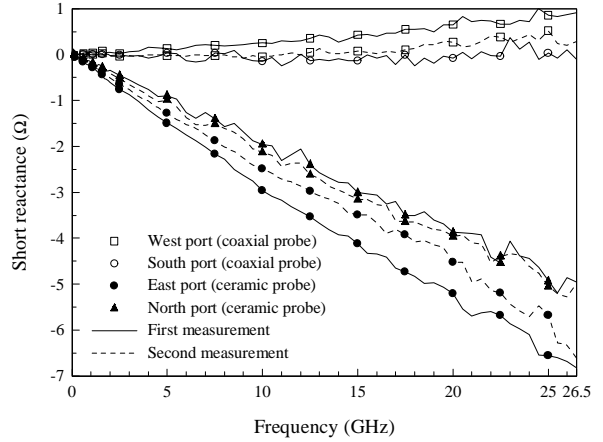


Fig. 2. Imaginary part of the SOLR short standard impedance. Repeated measurements were made with all four probe heads of the four-port test system and then corrected with a TRL calibration.

beginning and the end of the experiment. This large error bound shows that this SOLR calibration fails to reproduce the TRL calibration accurately (i.e. within the limits imposed by instrument drift and contact errors). This may be due in part to inconsistencies between the ISS we used, which realizes the short by placing the probe on a sheet of conductive metal, and the standard definitions developed by the manufacturer for an ISS that realizes the short by contacting a narrow conducting bar.

We also measured each of the standards on the SOLR calibration substrate with each probe type and our TRL calibration. Figure 2 shows the reactance of the short calibration standard used in the SOLR calibrations as measured by the TRL calibration. The figure shows a dramatic difference in short reactance between the coaxial probes and ceramic probes we used on the station. These differences forced us to customize our standard definitions for each probe type in the experiment as well.

Using the standard definitions we determined from our measurements in the SOLR calibration produced the error bound marked with circles in Fig. 1. While there is some improvement in the error

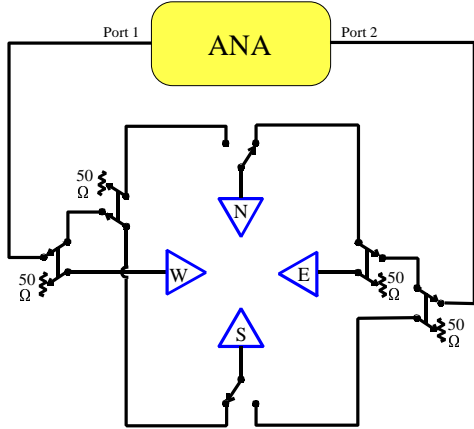


Fig. 3. Four port measurement system schematic.

bound, it is still considerably larger than the instrument drift, indicating additional systematic error.

Finally, we tried adjusting each of the SOLR standard definitions manually in an attempt to duplicate as closely as possible the TRL calibration. The minimum error bound we were able to achieve is marked with squares in Fig. 1. This optimization method was fairly successful, but the error bound is still well above the instrument drift. However, our measurements also showed that the real components of the impedances of the standards on the ISS varied somewhat with frequency, phenomena that could not be accounted for by adjusting C_o , L_s , and L_t . This may explain the additional error.

ORTHOGONAL SOLR CALIBRATION

We used a combination of two in-line TRL calibrations performed in the orthogonal planes of the four-port measurement system of Fig. 3 to verify orthogonal SOLR calibration. The system is comprised of a two-port microwave test set connected to four probe heads with a coaxial switch matrix to provide repeatable electrical connections without cable disconnection or repositioning of the probes. The west and south probes were of a coaxial construction and had a 150 μm pitch; the north and

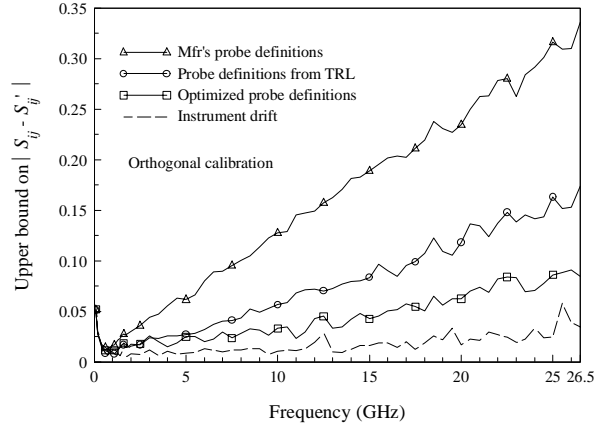


Fig. 4. Measurement error bounds for an orthogonal SOLR calibration. The various curves represent different SOLR standard definitions. The error bound due to test set drift and contact errors is shown as a dashed line for comparison.

east probes were of a ceramic construction and had a 250 μm pitch.

To perform the orthogonal TRL calibration, we first set the switches so that port one of our vector network analyzer was connected to the west probe and port 2 to the east probe (see Fig. 3), and then performed a one-tier in-line TRL between them. We then set the switches so that port one of our vector network analyzer was connected to the north probe and port 2 of the analyzer was connected to the south probe, and performed a second tier in-line TRL calibration between these probes. This second-tier calibration determines two “error boxes” that can be used to translate between the east and west measurement reference planes and the north and south reference planes. By cascading only one of these error boxes onto the one-tier east-west calibration, we created our orthogonal TRL calibration.

Figure 4 compares our orthogonal TRL and SOLR calibrations. The curve marked with triangles shows the error bound using the manufacturer’s standard definitions for C_o , L_s , and L_t . As in Fig. 1, the error bound is much larger than the instrument drift (dashed curve) determined from TRL

calibrations performed at the beginning and end of the experiment, thus indicating large systematic errors in the SOLR calibration.

We then measured the SOLR calibration artifacts with the TRL calibration and determined C_o , L_s , and L_t from the imaginary component of each respective impedance, as we did for the in-line calibration. Again, our measurements dictated that we use different standard definitions for each probe. Using these values for the standard definitions in the SOLR calibration produced the measurement error bound marked with circles in Fig. 3.

Finally, we adjusted C_o , L_s , and L_t to minimize the SOLR calibration measurement error. The resulting error bound is shown in the curve marked with squares in Fig. 3. The measurement error bound is still above the bound for the instrument drift. Nevertheless, it is much improved and not very different from the same bound for the in-line SOLR calibration. This indicates that the imperfect bend standard is not a large source of error in the SOLR calibration.

CONCLUSIONS

We found that the accuracy of the orthogonal and in-line SOLR calibrations we investigated were comparable: the use of a bend in the orthogonal calibration does not appear to cause significant error. However, using the standard definitions provided by the manufacturer, neither SOLR calibration reproduced the TRL calibration accurately. Although we achieved a considerable improvement in SOLR calibration by optimizing the standard definitions, that optimization relied upon an accurate reference calibration to guide the process.

Table 1. SOLR standard definitions.

	Port	C_o (fF)	L_s (pH)	L_t (pH)
Manufacturer	1	-1.0	8.8	1.6
	2	-10.5	9.6	2.1
From TRL	1	-9.1	1.3	-25.5
	2	-10.6	-41.4	-19.1
Optimized for in-line calibration	1	-9.0	3.0	1.6
	2	-13.0	-31.0	2.1
Optimized for orthogonal calib.	1	-9.0	3.0	7.0
	2	-6.0	-41.0	-49.0

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